

General Description

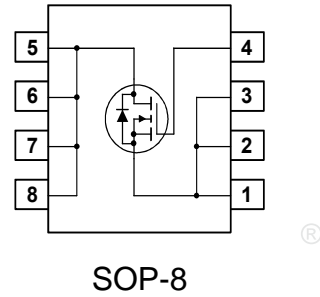
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$ and fast switching speed.

Applications

- DC/DC converters

Features

- $V_{DS(V)} = 30V$
- $I_D = 10.2A$ ($V_{GS} = 10V$)
- $R_{DS(ON)} < 14m\Omega$ ($V_{GS}=10V$)
- $R_{DS(ON)} < 17 m\Omega$ ($V_{GS}=4.5V$)
- High performance trench technology for extremely low $r_{DS(on)}$
- Low gate charge
- High power and current handling capability
- RoHS Compliant



MOSFET Maximum Ratings $T_A = 25^\circ C$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DSS}	Drain to Source Voltage	30	V
V_{GS}	Gate to Source Voltage	± 20	V
I_D	Drain Current		
	Continuous ($T_A = 25^\circ C, V_{GS} = 10V, R_{\theta JA} = 50^\circ C/W$)	10.2	A
	Continuous ($T_A = 25^\circ C, V_{GS} = 4.5V, R_{\theta JA} = 50^\circ C/W$)	9.3	A
	Pulsed	80	A
E_{AS}	Single Pulse Avalanche Energy (Note 1)	57	mJ
P_D	Power dissipation	2.5	W
	Derate above $25^\circ C$	20	mW/ $^\circ C$
T_J, T_{STG}	Operating and Storage Temperature	-55 to 150	$^\circ C$

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case (Note 2)	25	$^{\circ}C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 2a)	50	$^{\circ}C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 2b)	125	$^{\circ}C/W$

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$B_{V_{DS}}$	Drain to Source Breakdown Voltage	$I_D = 250\mu A, V_{GS} = 0V$	30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24V$ $V_{GS} = 0V$ $T_J = 150^{\circ}C$			1 250	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$			± 100	nA
$V_{GS(TH)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu A$	1.2		2.5	V
$r_{DS(on)}$	Drain to Source On Resistance	$I_D = 10.2A, V_{GS} = 10V$ $I_D = 9.3A, V_{GS} = 4.5V$ $I_D = 10.2A, V_{GS} = 10V,$ $T_J = 150^{\circ}C$		11.0 13.8 17.5	14.0 17.0 22.7	m Ω
C_{ISS}	Input Capacitance			897		pF
C_{OSS}	Output Capacitance	$V_{DS} = 15V, V_{GS} = 0V,$ $f = 1MHz$		190		pF
C_{RSS}	Reverse Transfer Capacitance			111		pF
R_G	Gate Resistance	$V_{GS} = 0.5V, f = 1MHz$	0.7	2.9	5.0	Ω
$Q_{g(TOT)}$	Total Gate Charge at 10V	$V_{GS} = 0V$ to 10V		17	26	nC
$Q_{g(5)}$	Total Gate Charge at 5V	$V_{GS} = 0V$ to 5V		9	14	nC
$Q_{g(TH)}$	Threshold Gate Charge	$V_{GS} = 0V$ to 1V		0.9	1.4	nC
Q_{gs}	Gate to Source Gate Charge			2.5		nC
Q_{gs2}	Gate Charge Threshold to Plateau			1.7		nC
Q_{gd}	Gate to Drain "Miller" Charge			3.3		nC
t_{ON}	Turn-On Time				54	ns
$t_{d(ON)}$	Turn-On Delay Time			7		ns
t_r	Rise Time	$V_{DD} = 15V, I_D = 10.2A$		29		ns
$t_{d(OFF)}$	Turn-Off Delay Time	$V_{GS} = 10V, R_{GS} = 16\Omega$		45		ns
t_f	Fall Time			18		ns
t_{OFF}	Turn-Off Time				94	ns
V_{SD}	Source to Drain Diode Voltage	$I_{SD} = 10.2A$ $I_{SD} = 2.1A$			1.25 1.0	V V
t_{rr}	Reverse Recovery Time	$I_{SD} = 10.2A, dI_{SD}/dt = 100A/\mu s$			19	ns
Q_{RR}	Reverse Recovered Charge	$I_{SD} = 10.2A, dI_{SD}/dt = 100A/\mu s$			9.5	nC

Notes:

- Starting $T_J = 25^{\circ}C, L = 1mH, I_{AS} = 10.7A, V_{DD} = 30V, V_{GS} = 10V$.
- $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design.
 - 50 $^{\circ}C/W$ when mounted on a 1in² pad of 2 oz copper.
 - 125 $^{\circ}C/W$ when mounted on a minimum pad.

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

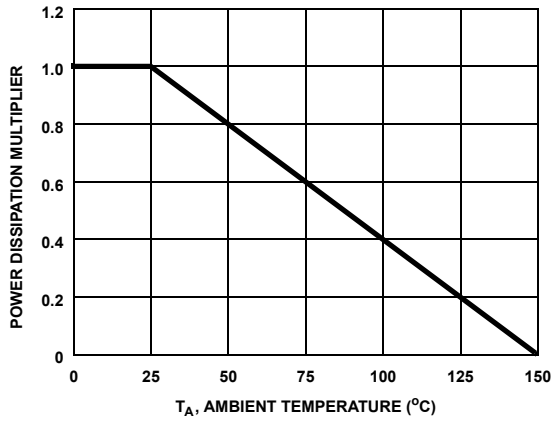


Figure 1. Normalized Power Dissipation vs Ambient Temperature

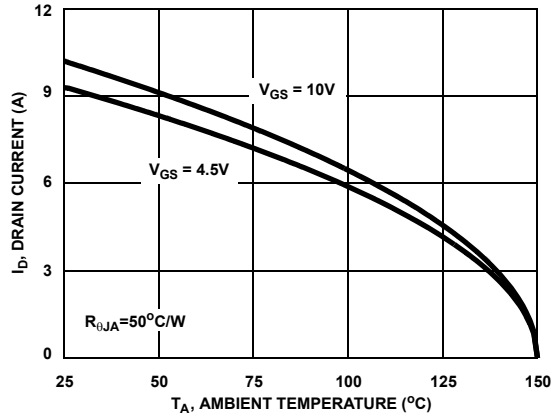


Figure 2. Maximum Continuous Drain Current vs Ambient Temperature

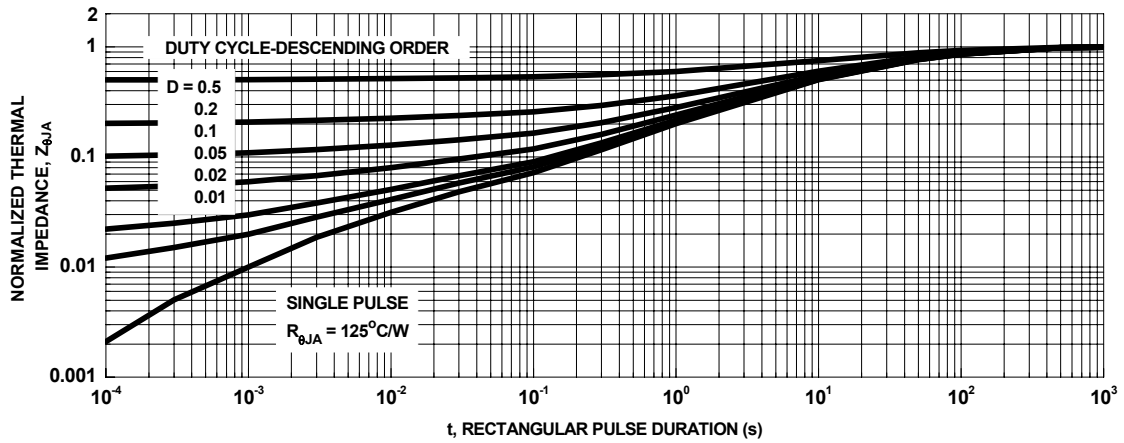


Figure 3. Normalized Maximum Transient Thermal Impedance

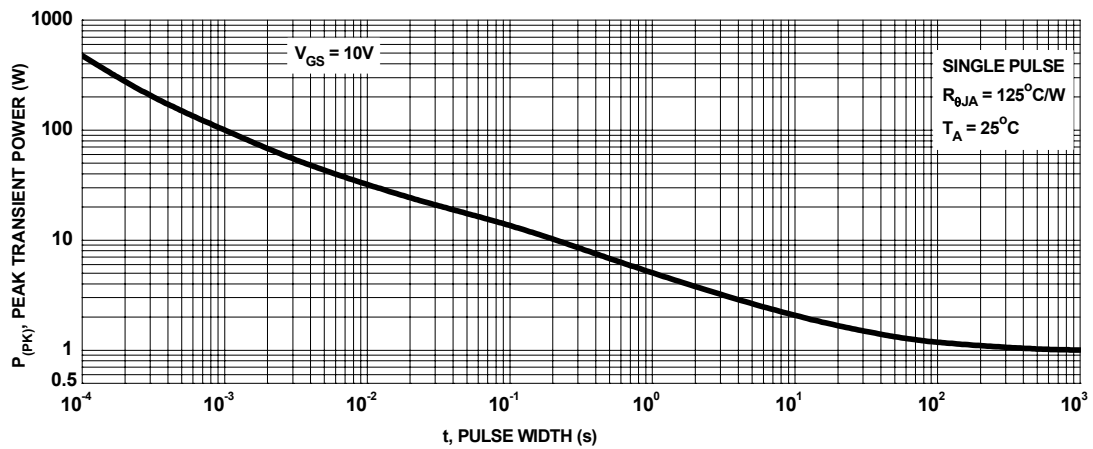


Figure 4. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

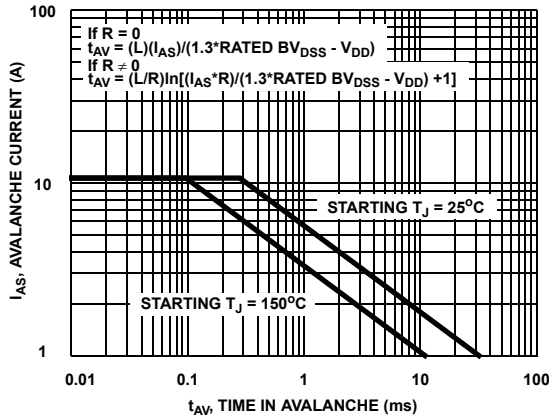


Figure 5. Unclamped Inductive Switching Capability

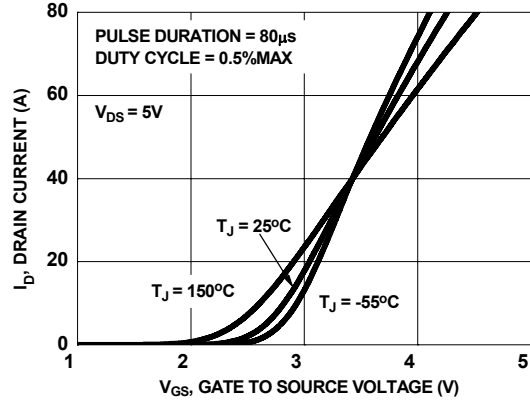


Figure 6. Transfer Characteristics

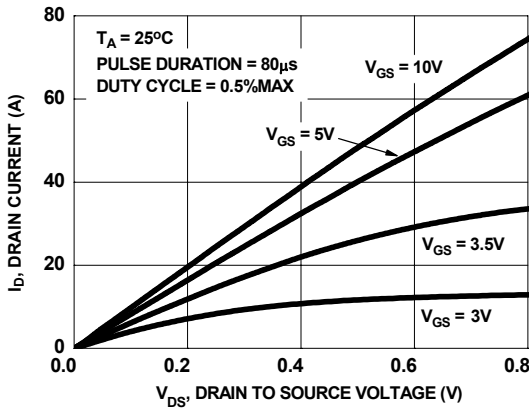


Figure 7. Saturation Characteristics

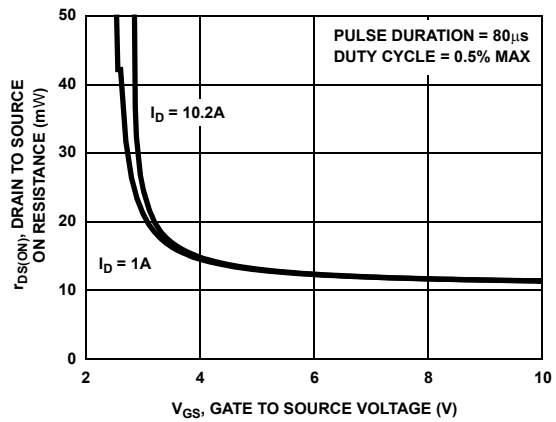


Figure 8. Drain to Source On Resistance vs Gate Voltage and Drain Current

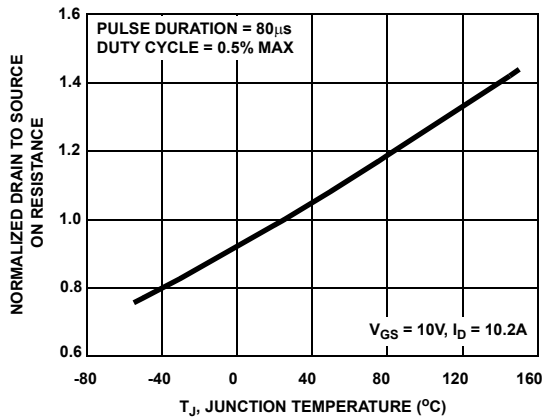


Figure 9. Normalized Drain to Source On Resistance vs Junction Temperature

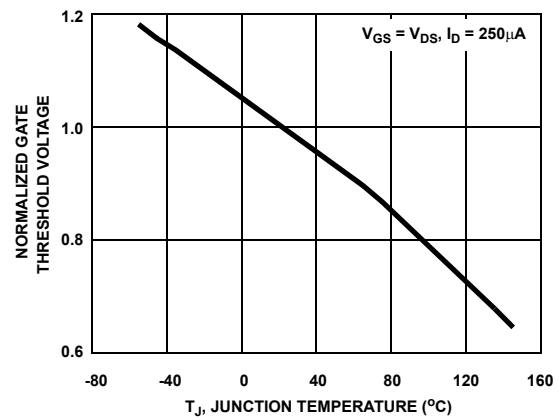


Figure 10. Normalized Gate Threshold Voltage vs Junction Temperature

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

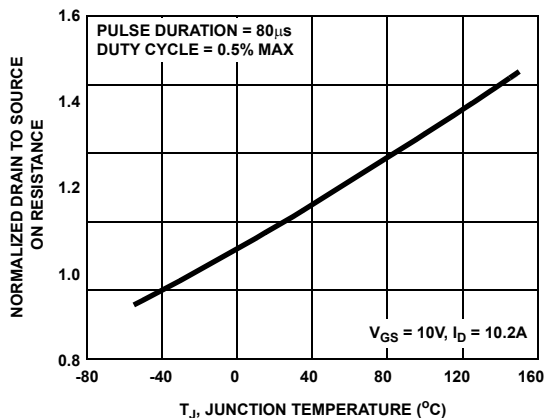


Figure 11. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

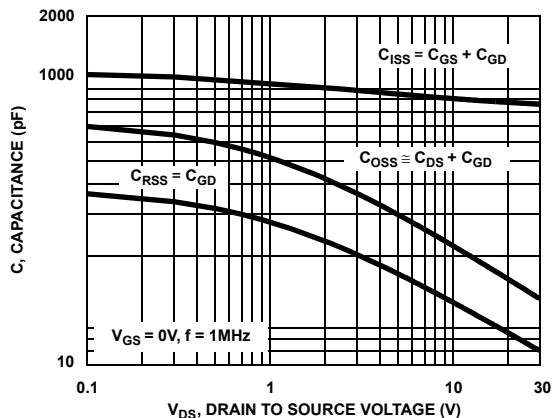


Figure 12. Capacitance vs Drain to Source Voltage

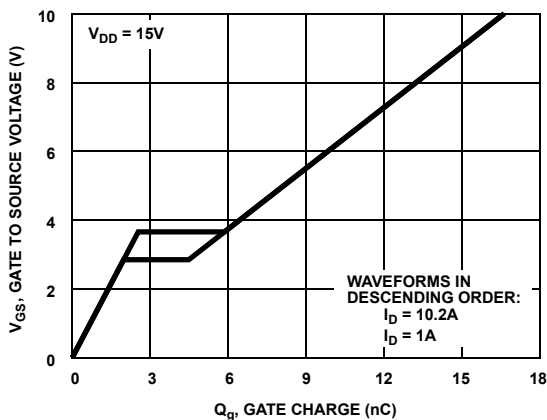


Figure 13. Gate Charge Waveforms for Constant Gate Currents

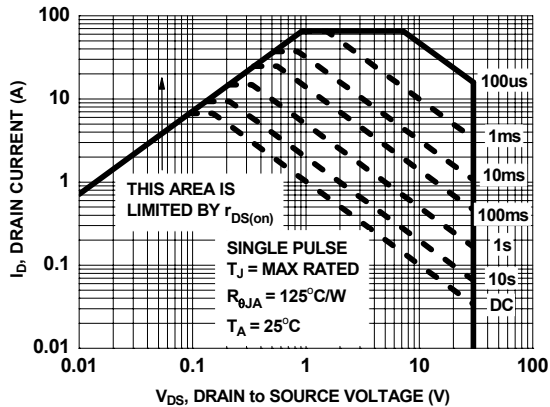


Figure 14. Forward Bias Safe Operating Area

Test Circuits and Waveforms

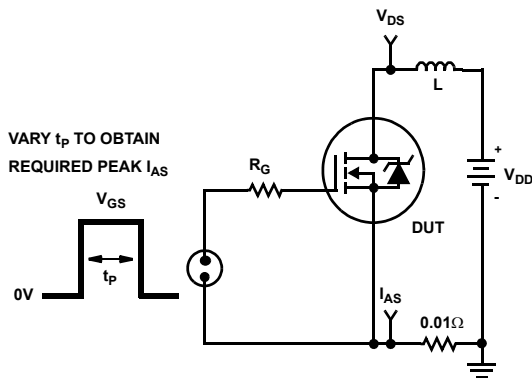


Figure 15. Unclamped Energy Test Circuit

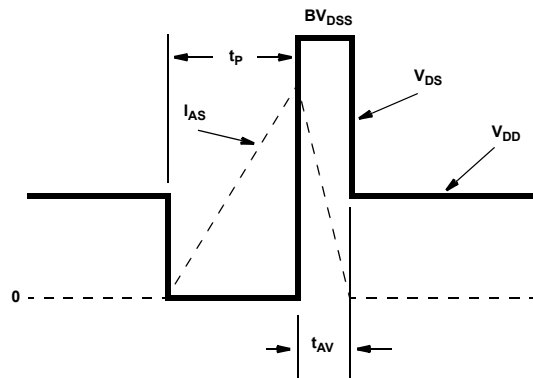


Figure 16. Unclamped Energy Waveforms

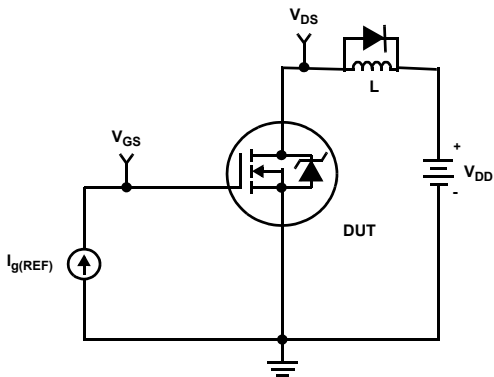


Figure 17. Gate Charge Test Circuit

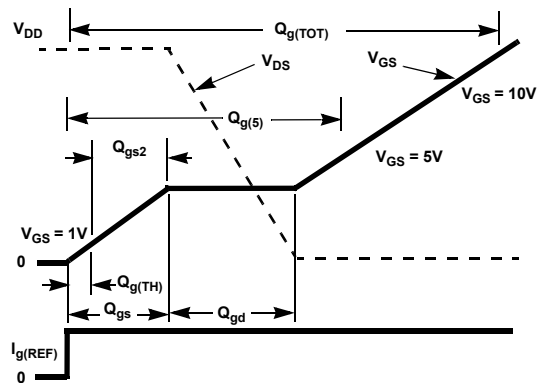


Figure 18. Gate Charge Waveforms

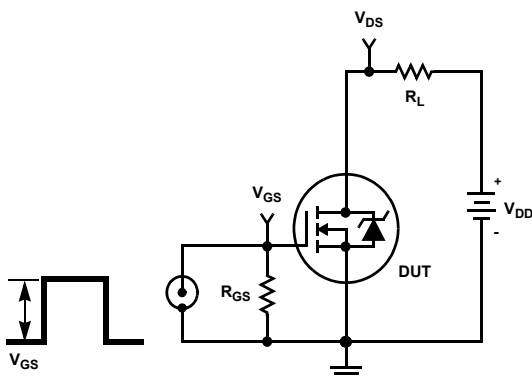


Figure 19. Switching Time Test Circuit

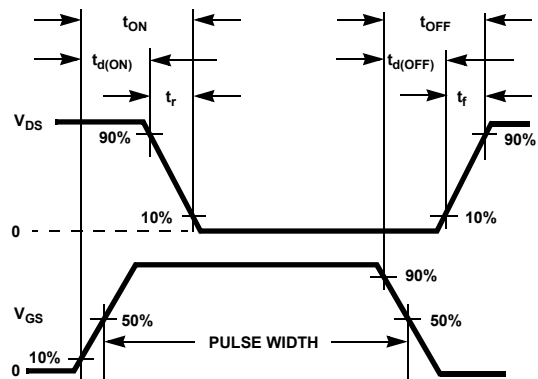
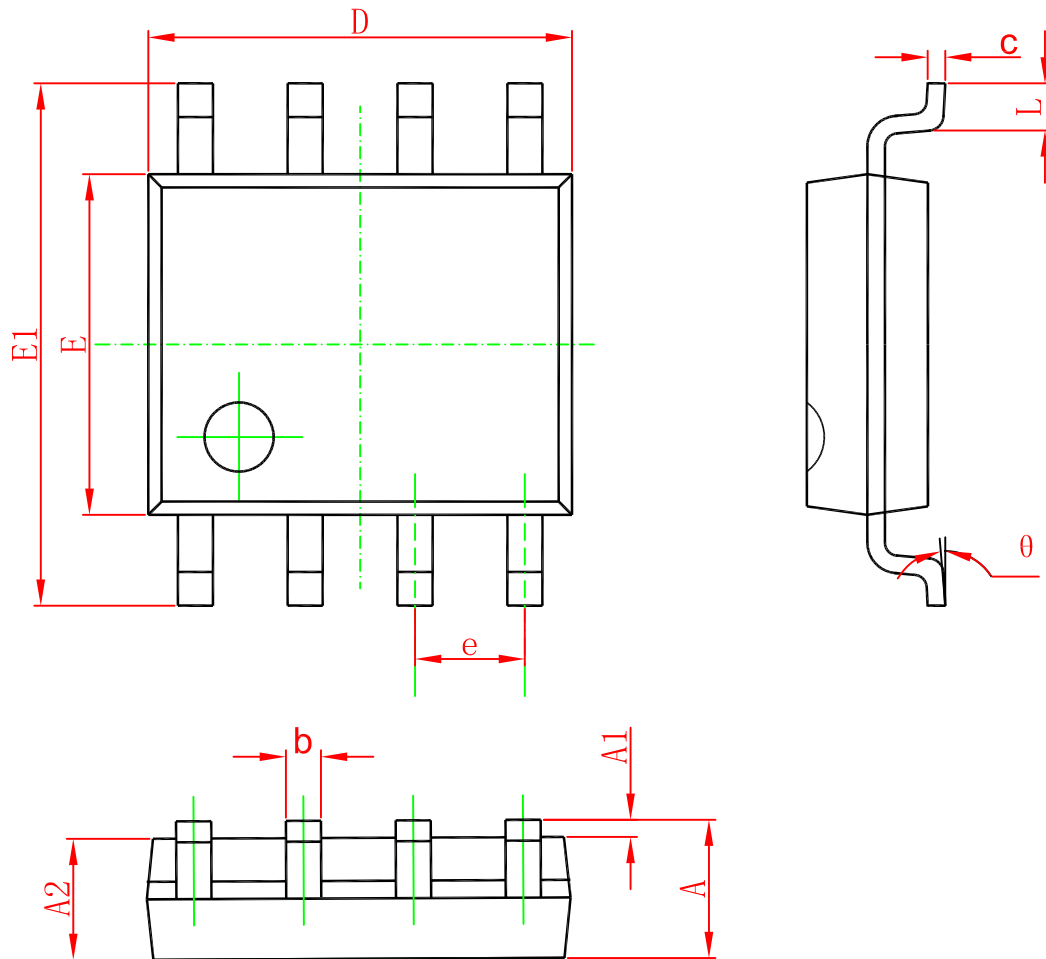


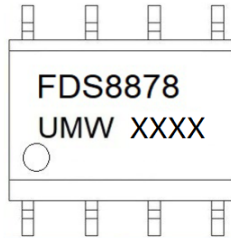
Figure 20. Switching Time Waveforms

Package Mechanical Data SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Marking



Ordering information

Order code	Package	Baseqty	Deliverymode
UMW FDS8878	SOP-8	3000	Tape and reel

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